

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of
K. OKAJIMA, et al.

Serial No.: To Be Assigned

Art Unit: To Be Assigned

Filed: Concurrently Herewith

Examiner: To Be Assigned

For: Method For Forming Solder-Resist Film

TRANSMITTAL

Honorable Commissioner of
Patents and Trademarks
Washington, D.C. 20231

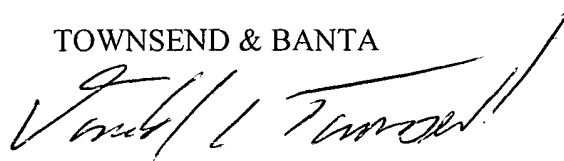
Sir:

In accordance with the provisions of 37 CFR 1.55 and the requirements of 35 U.S.C. 119, attached hereto is a certified copy of the priority application, Japanese Patent Application No. 2002-224827 filed August 1, 2002 .

It is respectfully requested that applicant be granted the benefit of the filing date of the foreign application and that receipt of this priority document be acknowledged in due course.

Respectfully submitted,

TOWNSEND & BANTA



Donald E. Townsend
Reg. No. 22,069

Date: July 31, 2003

TOWNSEND & BANTA
601 Pennsylvania Ave., N.W.
Suite 900, South Building
Washington, D.C. 20004
(202) 220-3124

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION TRANSMITTAL LETTER

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



Sir:

Transmitted herewith for filing pursuant to 37 C.F.R. 1.53 is the patent application of:

INVENTORS:

Keiichi OKAJIMA
1-10-22-704 Chuo, Joto-ku, Osaka-city,
Osaka 536-0005, Japan

Hiroshi ODA
7-2-301, Asahigaoka, Toyonaka-city,
Osaka 561-0085, Japan

Takahiro NAKANO
1-43-918, Shimeien, Ibaraki-city,
Osaka 567-0043, Japan

FOR: Method For Forming Solder-Resist Film

Enclosed are:

- X (3) three sheets of drawings.
- An Assignment of the invention to: Nippon Paint Co., Ltd.
- An associate power of attorney.
- X A Notice of Informal Filing of New Patent Application.

The filing fee is calculated as follows:

	CLAIMS AS	FILED	SMALL ENTITY		OTHER THAN A SMALL ENTITY
FOR	NO. FILED	NO. EXTRA	RATE FEE		RATE FEE
BASIC FEE			\$375		\$ 750
Total Claims	12-20=	-0-	x9=	or	x18= -0-
Indep claims	2 -3=	-0-	X42= -0-	or	x84= -0-
[] Multiple	Dep claims	-0-	+140= -0-	or	+280= -0-
			TOTAL		TOTAL \$ 750

X Check in the amount of \$ 750 (for the initial filing fee) is enclosed.

 The Commissioner is hereby authorized to charge \$ to Deposit Account No. 20-1424 for the filing fee listed above.

 The Commissioner is hereby authorized to charge \$ to the credit card identified in the attached Credit Card Payment Form for the filing fee listed above.

X The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.

 x Any additional fees under 37 CFR 1.16 for the presentation of extra claims.

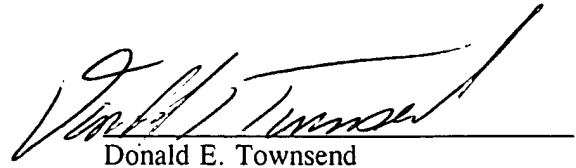
 x Any patent application processing fees under 37 CFR 1.17.

X The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 20-1424. A duplicate copy of this sheet is attached.

 x Any patent application processing fees under 37 CFR 1.17, including extension of time fees.

 x Any filing fees under 37 CFR 1.16 for the presentation of extra claims.

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Donald E. Townsend", is written over a horizontal line.

Donald E. Townsend
Reg. No. 22,069

Date: July 31, 2003

LAW OFFICES OF TOWNSEND & BANTA
Suite 900, South Building
601 Pennsylvania Ave., N.W.
Washington, D.C. 20004
(202) 220-3124